

Attorney's Docket No. 018976-144



As a below-named inventor, I hereby declare that: My residence, post office address and citizenship are as stated below next to my name; I BELIEVE I AM THE ORIGINAL, FIRST AND SOLE INVENTOR (if only one name is listed below) OR AN ORIGINAL, FIRST AND JOINT INVENTOR (if more than one name is listed below) OF THE SUBJECT MATTER WHICH IS CLAIMED AND FOR WHICH A PATENT IS SOUGHT ON THE INVENTION ENTITLED:							
ELECTRONIC COMPONENT CHIP FEEDER AND MANUFACTURING METHOD OF ELECTRONIC							
DEVICES USING ELECTRONIC COMPONENT CHIPS							
the specification of which							
(check one)	is attached hereto;						
,	was filed on September 22, 1999 as						
	Application No.						
	and was amended on September 22, 1999 ; (if applicable)						
I HAVE REVIEWED AND UNDERSTAND THE CONTI INCLUDING THE CLAIMS, AS AMENDED BY ANY A							
I ACKNOWLEDGE THE DUTY TO DISCLOSE TO THE OFFICE ALL INFORMATION KNOWN TO ME TO BE MATERIAL TO PATENTABILITY AS DEFINED IN TITLE 37, CODE OF FEDERAL REGULATIONS, Sec. 1.56 (as amended effective March 16, 1992);							
I do not know and do not believe the said invention was ever known or used in the United States of America before my or our invention thereof, or patented or described in any printed publication in any country before my or our invention thereof or more than one year prior to said application; that said invention was not in public use or on sale in the United States of America more than one year prior to said application; that said invention has not been patented or made the subject of an inventor's certificate issued before the date of said application in any country foreign to the United States of America on any application filed by me or my legal representatives or assigns more than twelve months prior to said application;							
I hereby claim foreign priority benefits under Title 35, United States Code Sec. 119 and/or Sec. 365 of any foreign application(s) for patent or inventor's certificate as indicated below and have also identified below any foreign application for patent or inventor's certificate on this invention having a filing date before that of the application(s) on which priority is claimed:							

COMBINED DECLARATION AND POWER OF ATTORNEY			Attorney's Docket No. 018976-144				
COUNTRY/INTERNATIONAL	APPLICATION	NUMBER	DATE OF FILING (day, month, year)		PRIORITY CLAIMED		
JAPAN	10-2736	40	2	8 Sept. 98	YES_X_ NO_		
		-		·	YES_ NO_		
I hereby appoint the following attorneys and agent(s) to prosecute said application and to transact all business in the Patent and Trademark Office connected therewith and to file, prosecute and to transact all business in connection with international applications directed to said invention:							
William L. Mathis Robert S. Swecker Rlaton N. Mandros Benton S. Duffett, Jr. Benton S. Duff	R. Danny Huntington Eric H. Weisblatt James W. Peterson Teresa Stanek Rea Robert E. Krebs William C. Rowlan T. Gene Dillahunty Patrick C. Keane Bruce J. Boggs, Jr. William H. Benz Peter K. Skiff Richard J. McGrath Matthew L. Schnei Michael G. Savage Platon N. Mandr Burns, Doane, P.O. Box 1404 Alexandria, Virg. N. Mandros	30 26 30 30 4 30 25 32 25 31 1 29 der 32 32	4		33,815 34,040 31,979 III 36,341 36,086 is 35,023		
Thereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.							
FULL NAME OF SOLE OR FIRST INVENTOR		SIGNATURE	•		DATE		
Kiyoyuki NAKAGAWA		Kiyoyuk	; Nak	agawa	October 13, 1999		
RESIDENCE Takefu-shi, Fukui-ken, Japan				CITIZENSHIP Japan			
POST OFFICE ADDRESS							
c/o (A170) Intellectual Property Dept., Murata M: FULL NAME OF SECOND JOINT INVENTOR,		6-10, Tenjin 2-cho SIGNATURE			DATE		
Kenichi FUKUDA	, 22 2212	Kerich	· F	vkoda	October 13. 1989		
RESIDENCE		7,0,101		CITIZENSHIP			
Sabae-shi, Fukui-ken, Japan Japan							
POST OFFICE ADDRESS		-					
c/o (A170) Intellectual Property Dept., Murata M. FULL NAME OF THIRD JOINT INVENTOR, II		6-10, Tenjin 2-cho SIGNATURE	me, Nagao	kakyo-shi, Kyoto-fu (517-8555, Japan DATE		
RESIDENCE		<u>. </u>		CITIZENSHIP	1		
POST OFFICE ADDRESS							

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ASSIGNMENT

(TAIOL)



THIS ASSIGNMENT, by <u>KIYOYUKI NAKAGAWA</u>, and <u>KENICHI FUKUDA</u>, residing at <u>TAKEFU-SHI</u>, <u>FUKUI-KEN</u>, <u>JAPAN</u> and <u>SABAE-SHI</u>, <u>FUKUI-KEN</u>, <u>JAPAN</u> (hereinafter referred to as "the Assignors"), respectively, witnesseth:

WHEREAS, the Assignors have invented certain new and useful improvements in ELECTRONIC COMPONENT CHIP FEEDER AND MANUFACTURING METHOD OF ELECTRONIC DEVICES USING ELECTRONIC COMPONENT CHIPS set forth in an application for Letters Patent of the United States, □ which is a provisional application to be filed herewith; □ which is a non-provisional application having an oath or declaration executed on even date herewith prior to filing of application; ☑ bearing Application No. __09/401,526 _____, and filed on SEPTEMBER 22, 1999; and

WHEREAS, MURATA MANUFACTURING CO., LTD., a corporation duly organized under and pursuant to the laws of JAPAN and having its principal place of business at 26-10. Teniin 2-chome. Nagaokakyo-shi, Kyoto-fu 617-8555, Japan (hereinafter referred to as "the Assignee"), is desirous of acquiring the entire right, title, and interest in and to said inventions, the right to file applications on said inventions and the entire right, title and interest in and to any applications, including provisional applications for Letters Patent of the United States or other countries claiming priority to said application, and in and to any Letters Patent or Patents. United States or foreign, to be obtained therefor and thereon.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and sufficient consideration, the receipt of which is hereby acknowledged, the Assignors have sold, assigned, transferred, and set over, and by these presents do sell, assign, transfer, and set over, unto the Assignee, its successors, legal representatives, and assigns the entire right, title, and interest in and to the above-mentioned inventions, the right to file applications on said inventions and the entire right, title and interest in and to any applications for Letters Patent of the United States or other countries claiming priority to said applications, and any and all Letters Patent or Patents of the United States of America and all foreign countries that may be granted therefor and thereon, and in and to any and all applications claiming priority to said applications, divisions, continuations, and continuations-in-part of said applications, and reissues and extensions of said Letters Patent or Patents, and all rights under the International Convention for the Protection of Industrial Property, the same to be held and enjoyed by the Assignee, for its own use and behalf and the use and behalf of its successors, legal representatives, and assigns, to the full end of the term or terms for which Letters Patent or Patents may be granted as fully and entirely as the same would have been held and enjoyed by the Assignors had this sale and assignment not been made;

AND for the same consideration, the Assignors hereby covenant and agree to and with the Assignee, its successors, legal representatives, and assigns, that, at the time of execution and delivery of these presents, the Assignors are the sole and lawful owners of the entire right, title, and interest in and to the inventions set forth in said applications and said applications, including provisional applications, above-mentioned, and that the same are unencumbered, and that the Assignors have good and full right and lawful authority to sell and convey the same in the manner herein set forth;



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Application No.

AND for the same consideration, the Assignors hereby covenant and agree to and with the Assignee, its successors, legal representatives, and assigns that the Assignors will, whenever counsel of the Assignee, or the counsel of its successors, legal representatives, and assigns, shall advise that any proceeding in connection with said inventions or said applications for Letters Patent or Patents, or any proceeding in connection with Letters Patent or Patents for said inventions in any country, including interference proceedings, is lawful and desirable, or that any application claiming priority to said application, division, continuation, or continuation-in-part of any applications for Letters Patent or Patents, or any reissue or extension of any Letters Patent or Patents to be obtained thereon, is lawful and desirable, sign all papers and documents, take all lawful oaths, and do all acts necessary or required to be done for the procurement, maintenance, enforcement, and defense of Letters Patent or Patents for said inventions, without charge to the Assignee, its successors, legal representatives, and assigns, but at the cost and expense of the Assignee, its successors, legal representatives, and assigns;

AND the Assignors hereby authorize and request the attorneys of Burns, Doane, Swecker & Mathis, L.L.P. of Alexandria, Virginia to insert in the spaces provided above the filing date, application number, and attorney docket number of said application when known.

AND the Assignors hereby request the Commissioner of Patents to issue any and all said Letters Patent of the United States to the Assignee as the Assignee of said inventions, the Letters Patent to be issued for the sole use and behalf of the Assignee, its successors, legal representatives, and assigns.

Date October 13, 1999	Signature of Assignor	kiyoyuki	Nakagawa
Date October 13. 1999		Kiyoyuki NAKA	GAWA
Date	Signature of Assignor	Kenichi FUKUD	
Date	Signature of Assignor		
Date	Signature of Assignor		-
Date	Signature of Assignor		
Date	Signature of Assignor _		
Date	Signature of Assignor _		